

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- · Optimized package with separate driver source pin
- Lower Profile TO-247-4 package body
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- · Halogen free, RoHS compliant

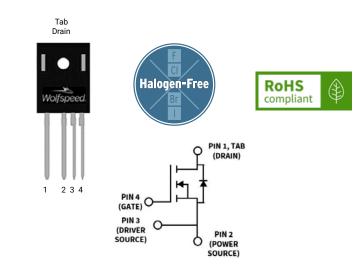
Benefits

- · Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters
- Solar/ESS
- UPS
- Battery Voltage Range: 400V-550V
- Enterprise PSU

Package



| Part Number | Package | Marking | | |
|--------------|--------------|--------------|--|--|
| C3M0045075K1 | T0-247-4L LP | C3M0045075K1 | | |

Key Parameters

| Parameter | Symbol | Min. | Тур. | Max | Unit | Conditions | Note |
|--|-----------------------------------|------|-------|----------------|--------------|---|---------|
| Drain - Source Voltage | V _{DS} | | | 750 | | T _c = 25°C | |
| Maximum Gate - Source Voltage | V _{GS(max)} | -8 | | +19 | v | Transient | |
| Operational Gate-Source Voltage | V _{GS op} | | -4/15 | | | Static | Note 1 |
| | I _D | | | 42 | A | $V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 175 \text{ °C}$ | Fig. 19 |
| DC Continuous Drain Current | | | | 31 | | $V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 175 \text{ °C}$ | Note 2 |
| Pulsed Drain Current | I _{DM} | | | 132 | | t _{Pmax} limited by T _{jmax} V _{GS} = 15V, T _C = 25 °C | Fig. 22 |
| Power Dissipation | P _D | | | 139 | W | $T_{c} = 25 ^{\circ} \text{C}, T_{J} = 175 ^{\circ} ^{\circ} ^{\circ}$ | Fig. 20 |
| Operating Junction and Storage Temperature | T _J , T _{stg} | | | -40 to +175 | °C | | |
| Solder Temperature | T _L | | | 260 | | According to JEDEC J-STD-020 | |
| Mounting Torque | M _D | | | 1 8.8 | Nm lbf-in | M3 or 6-32 screw | |

Note (1): Recommended turn-on gate voltage is 15V with $\pm 5\%$ regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

| Symbol | Parameter | Min. | Тур. | Max. | Unit | Test Conditions | Note |
|-----------------------|---|------|------|------|--|--|----------------|
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | 750 | | | ٧ | V _{GS} = 0 V, I _D = 100 μA | |
| $V_{GS(th)}$ | Gate Threshold Voltage | 1.8 | 2.6 | 3.8 | ٧ | V _{DS} = V _{GS} , I _D = 4.84 mA | T:- 11 |
| V GS(th) | | | 2.2 | | ٧ | $V_{DS} = V_{GS}$, $I_D = 4.84$ mA, $T_J = 175$ °C | Fig. 11 |
| I_{DSS} | Zero Gate Voltage Drain Current | | 1 | 50 | μΑ | V _{DS} = 750 V, V _{GS} = 0 V | |
| I _{GSS} | Gate-Source Leakage Current | | 10 | 250 | nA | V _{GS} = 15 V, V _{DS} = 0 V | |
| R _{DS(on)} | Drain-Source On-State Resistance | | 45 | 60 | mΩ | V _{GS} = 15 V, I _D = 17.6 A | Fig. 4, |
| · vos(on) | | | 68 | | | V _{GS} = 15 V, I _D = 17.6 A, T _J = 175°C | 5, 6 |
| g_{fs} | Transconductance | | 12.6 | | s | V _{DS} = 20 V, I _{DS} = 17.6 A | Fig. 7 |
| 915 | Transconductarios | | 13.1 | | | V _{DS} = 20 V, I _{DS} = 17.6 A, T _J = 175°C | 119.7 |
| C _{iss} | Input Capacitance | | 1606 | | | | |
| C_{oss} | Output Capacitance | | 95 | | pF | $V_{GS} = 0 \text{ V, } V_{DS} = 0 \text{V to } 500 \text{ V}$ | Fig. 17, |
| C_{rss} | Reverse Transfer Capacitance | | 8 | | | F = 1 MHz V _{AC} = 25 mV | |
| E _{oss} | C _{oss} Stored Energy | | 16 | | μJ | VAC = 25 IIIV | Fig. 16 |
| C _{o(er)} | Effective Output Capacitance (Energy Related) | | 118 | | pF | V _{GS} = 0 V, V _{DS} = 0 500V | Note: 3 |
| C _{o(tr)} | Effective Output Capacitance (Time Related) | | 165 | | pF | | |
| E _{on} | Turn-On Switching Energy (External Diode) | | 81 | | | V _{DS} = 500 V, V _{GS} = -4 V/15 V, I _D = 17.6 A, | Fig. 26, 28 |
| E _{OFF} | Turn Off Switching Energy (External Diode) | | 22 | | μJ | $R_{G(ext)} = 2.5 \Omega$, L= 99 μ H, $T_J = 175$ °C FWD = External SiC DIODE | |
| Eon | Turn-On Switching Energy (Body Diode FWD) | | 82 | | | V_{DS} = 500 V, V_{GS} = -4 V/15 V, I_{D} = 17.6 A, | Fig. 26, 28 |
| E _{OFF} | Turn-Off Switching Energy (Body Diode FWD) | | 20 | | μJ | $R_{G(ext)} = 2.5 \Omega$, L= 99 μ H, $T_J = 175$ °C FWD = Internal Body Diode | |
| $t_{\text{d(on)}} \\$ | Turn-On Delay Time | | 8 | | | | |
| t _r | Rise Time | | 11 | | $V_{DD} = 500 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 17.6 \text{ A}, R_{G(ext)} = 2.5 \Omega, L = 99 \mu\text{H}$ | Fig. 27, | |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time | | 19 | | ns | Timing relative to V _{DS} | 28 |
| t _f | Fall Time | | 8 | | | muuctive loau | |
| R _{G(int)} | Internal Gate Resistance | | 2.9 | | Ω | f = 1 MHz, V _{AC} = 25 mV | |
| Q_{gs} | Gate to Source Charge | | 19 | | V _{DS} = 500 V, V _{GS} = -4 V/15 V | | |
| Q_{gd} | Gate to Drain Charge | | 21 | | nC | I _D = 17.6 A | Fig. 12 |
| Qg | Total Gate Charge | | 65 | | | Per IEC60747-8-4 pg 21 | |

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V $C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V

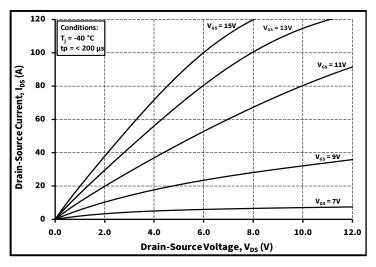
Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

| Symbol | Parameter | Тур. | Max. | Unit | Test Conditions | Note |
|------------------|---------------------------------------|------|------|------|---|------------------|
| V | V _{SD} Diode Forward Voltage | 4.9 | | ٧ | V _{GS} = -4 V, I _{SD} = 8.8 A, T _J = 25 °C | Fig. 8, 9, 10 |
| V SD | | 4.2 | | ٧ | V _{GS} = -4 V, I _{SD} = 8.8 A, T _J = 175 °C | |
| Is | Continuous Diode Forward Current | | 26 | Α | V _{GS} = -4 V, T _C = 25°C | |
| I _{SM} | Diode pulse Current | | 132 | Α | V_{GS} = -4 V, pulse width t_P limited by T_{jmax} | |
| t _{rr} | Reverse Recover time | 15 | | ns | V _{GS} = -4 V, I _{SD} = 17.6 A, V _R = 500 V dif/dt = 5835 A/µs, T ₁ = 175 °C | |
| Q _{rr} | Reverse Recovery Charge | 383 | | nC | | |
| l _{rrm} | Peak Reverse Recovery Current | 42 | | Α | , , | |
| t _{rr} | Reverse Recover time | 24 | | ns | | |
| Q _{rr} | Reverse Recovery Charge | 270 | | nC | V _{es} = -4 V, I _{sp} = 17.6 A, V _R = 500 V dif/dt = 2325 A/μs, Τ _ι = 175 °C | |
| l _{rrm} | Peak Reverse Recovery Current | 20 | | А | α, α 2525 / γ μος . , / ο | |

Thermal Characteristics

| Symbol | Parameter | Тур. | Unit | Test Conditions | Note |
|----------------|--|------|------|-----------------|---------|
| $R_{	heta JC}$ | Thermal Resistance from Junction to Case | 0.83 | °C/W | | Fig. 21 |

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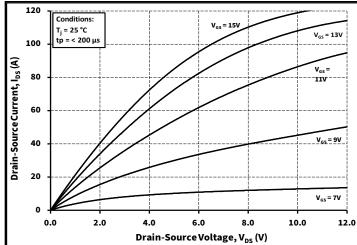
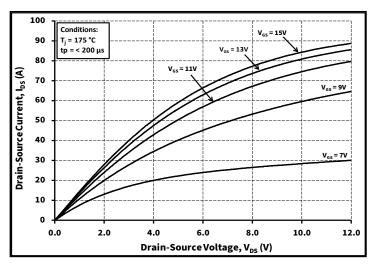


Figure 1. Output Characteristics T_J = -40 °C

Figure 2. Output Characteristics T_J = 25 °C



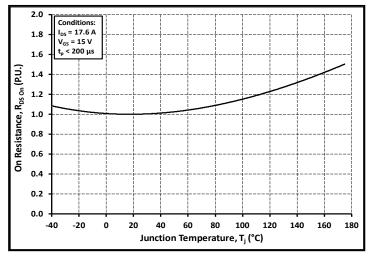
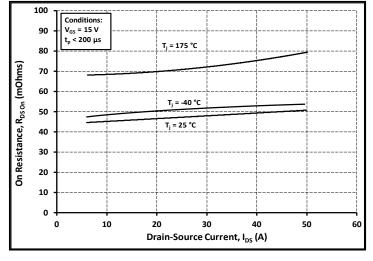


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



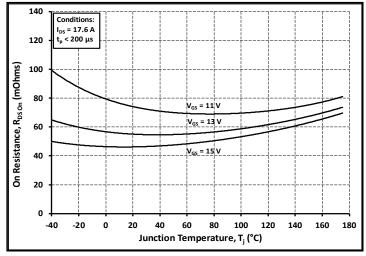


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

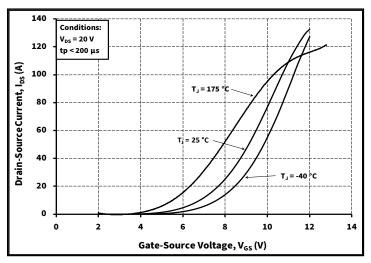


Figure 7. Transfer Characteristic for Various Junction Temperatures

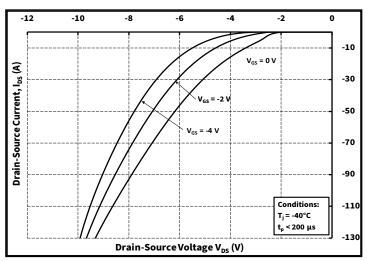


Figure 8. Body Diode Characteristic at -40 °C

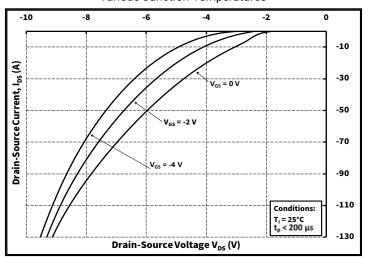


Figure 9. Body Diode Characteristic at 25 °C

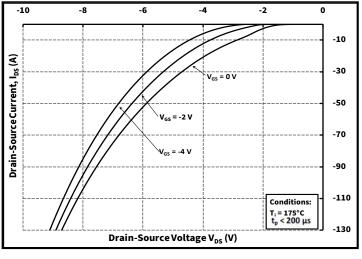


Figure 10. Body Diode Characteristic at 175 °C

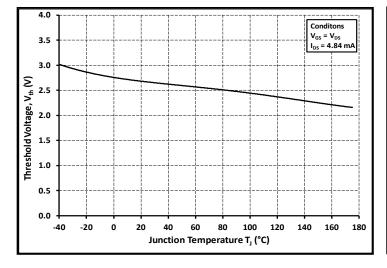


Figure 11. Threshold Voltage vs. Temperature

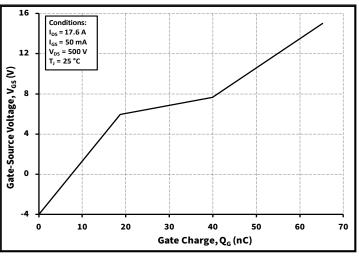
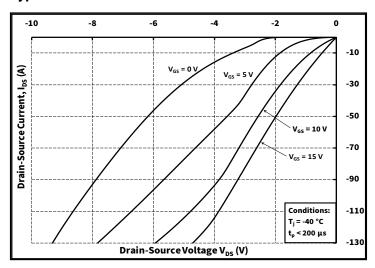
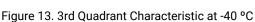


Figure 12. Gate Charge Characteristics





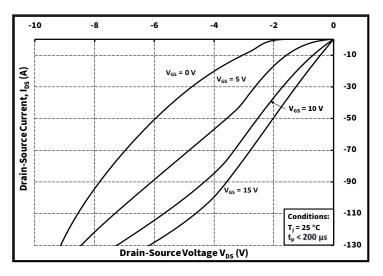


Figure 14. 3rd Quadrant Characteristic at 25 °C

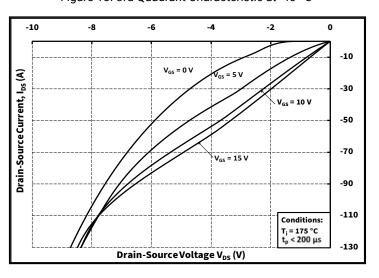


Figure 15. 3rd Quadrant Characteristic at 175 °C

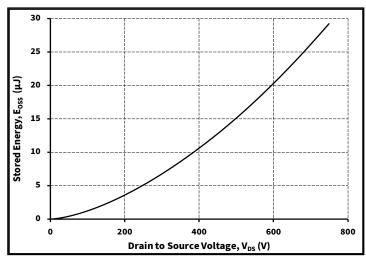


Figure 16. Output Capacitor Stored Energy

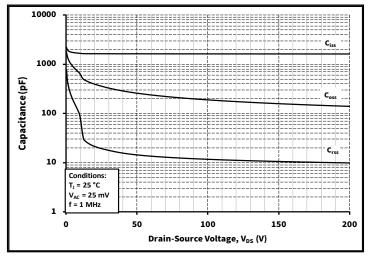


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

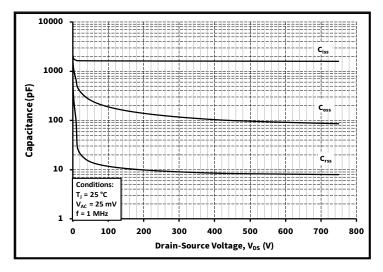


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 750V)

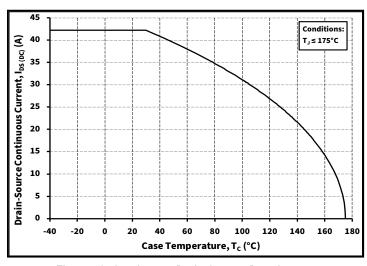


Figure 19. Continuous Drain Current Derating vs. Case Temperature

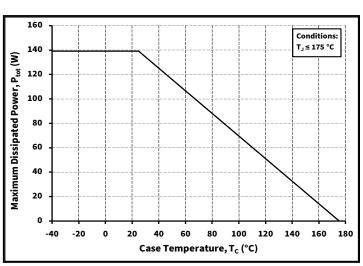


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

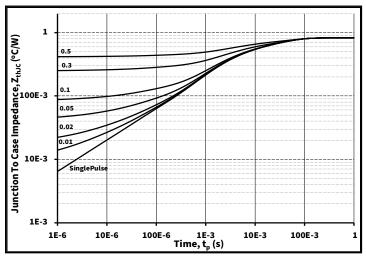


Figure 21. Transient Thermal Impedance (Junction - Case)

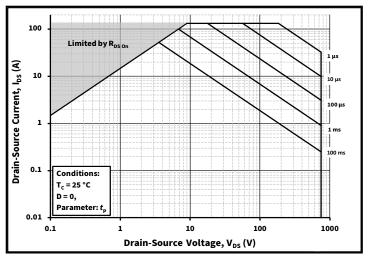


Figure 22. Safe Operating Area

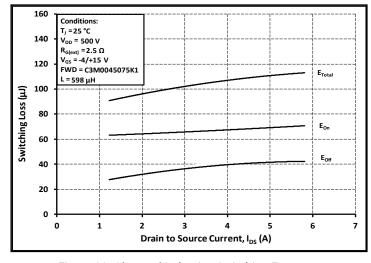


Figure 23. Clamped Inductive Switching Energy vs. Drain Current $(V_{DD} = 500V)$

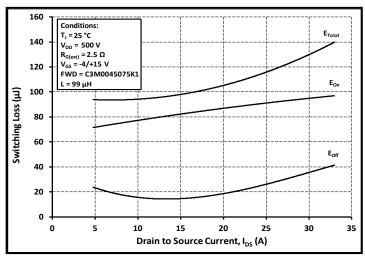


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 500V)

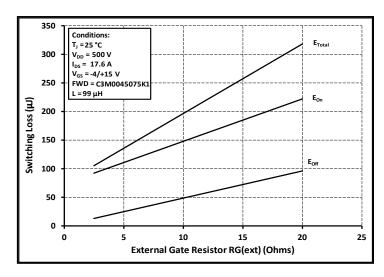


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

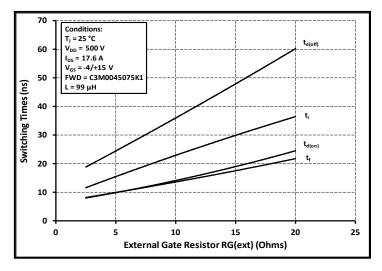


Figure 27. Switching Times vs. R_{G(ext)}

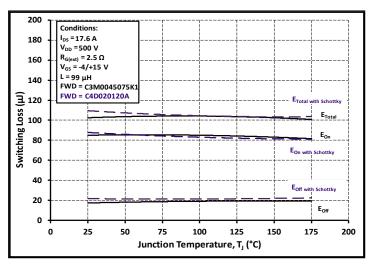


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

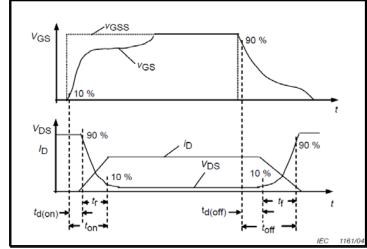


Figure 28. Switching Times Definition

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Test Circuit Schematic

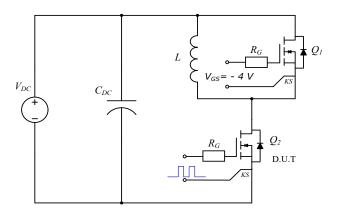
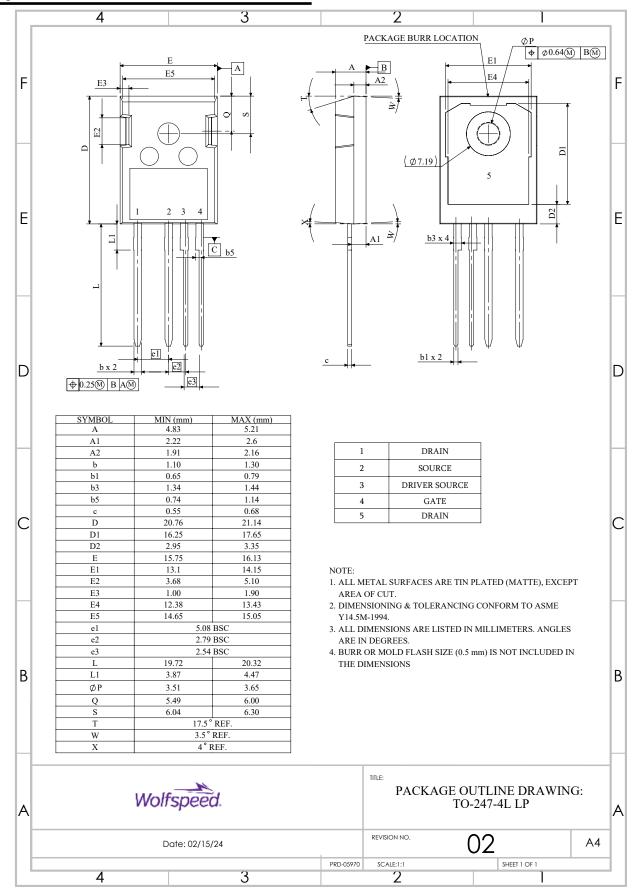


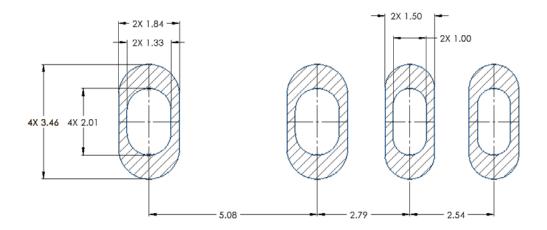
Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout

All dimensions in mm



Revision history

| Document Version | Date of release | Descriptiion of changes |
|------------------|-----------------|-------------------------|
| 1.0 | March-2024 | Initial datasheet |
| 2.0 | October - 2024 | Legal Disclaimer |

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